



Innovation for the next generation

PULSAR

4-Lane TDR

Time Domain Reflectometry | Return Loss | Skew

# Summary

In such a fast-paced and data-hungry industry, reducing test time provides a significant advantage to hightech providers seeking to increase productivity. MultiLane is dedicated to revolutionizing large-scale production testing with advanced, automate, high-through-put solutions.

Our solutions are geared toward automating the testing process, ensuring our partners receive precise, dependable measurements, while minimizing time spent testing.

Pulsar is a TDR that supports medium impedance characterization, and skew evaluation. Pulsar enables simultaneous testing on four channels and serves various critical applications in PCB and switch characterization, medium fault detection, and other essential industrial tasks. Crucially, Pulsar was designed with high throughput testing in mind, providing one of the fastest test times in the industry to best serve high scale production.

# multiLane

#### Introduction

Pulsar is a high throughput Time domain reflectometer. The true-differential TDR can determine the impedance profile and reflection loss on 4 channels simultaneously. It is designed and suited both for characterization as well as manufacturing.

Multilane's Pulsar provides detailed SI insights allowing the detection of minor impedance mismatches and enabling proactive maintenance and optimization.

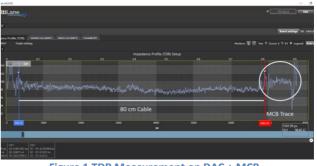


Figure 1 TDR Measurement on DAC + MCB.

#### **Key Features**

- High Resolution TDR.
- Low cost quadruple 12/7 ps Rise Time Domain Reflectometry.
- Return Loss measurement.
- 4 ports per module expandable up to 32+
- Low power dissipation.

#### **TDR Applications**

- Switch Testing
- Semiconductor Testing
- PCB Testing and Probing
- Location of impedance discontinuities for Automotive Ethernet

#### Software Features

Pulsar's software allows the characterization of the DUT's impedance profile and return loss. The available or custom masks come with a Pass/Fail indicator to ensure the DUT's reliability in a few seconds.

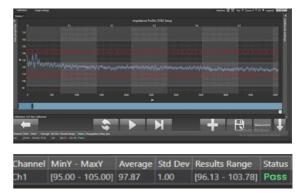


Figure 2 Impedance profile mask with pass verdict.



Figure 3 Switch Testing using 4 Pulsars.



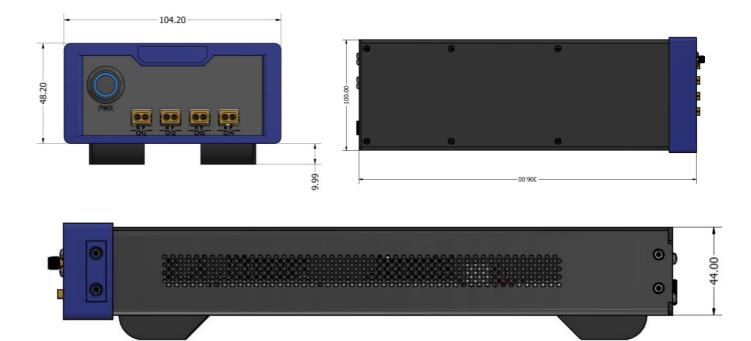
# **TDR Specifications**

Parameter	Specifications 35 GHz	
S&H Bandwidth	35Ghz	
S&H Gain Flatness	[-0,5 , 0.5] dB	
Differential amplitude	100	
with 100 $\Omega$ DUT	100 mVpp min 1000 mVpp max	
Termination	1000 mvpp max	
Step response		
Rise/Fall Time	12 ps	
(20%-80%)		
TDR resolution	1.5 mm	
Random Aperture	60 fs simulated	
Jitter	oo is sinuated	
Electrical channel	(4X) 1X2 ML SMPM	
connectors	(4A) IAZ IVIL SIVIFIVI	
Data Input	AC coupled	
Normal Operating	0 - 65 °C	
Temperature		
Instrument Automatic	65 °C (manual reboot is	
Shutoff	needed to turn it back on)	
<b>Power Dissipation</b>	2.3 A @12V	

Parameter	Specifications 70 GHz	
S&H Bandwidth	70Ghz	
S&H Gain Flatness	[-0,5 , 0.5] dB	
Differential amplitude	70 mVpp min	
with 100 $\Omega$ DUT	700 mVpp max	
Termination		
Step response		
Rise/Fall Time	7 ps	
(20%-80%)		
TDR resolution	1 mm	
Random Aperture	30 fs simulated	
Jitter	SU IS SIMulated	
Electrical channel	(2X) 1X4 ML SMPS	
connectors	(27) 174 IVIL SIVIPS	
Data Input	AC coupled	
Normal Operating	0 - 65 °C	
Temperature	0-05 C	
Instrument Automatic	65 °C (manual reboot is	
Shutoff	needed to turn it back on)	
Power Dissipation	2.3 A @12V	



## **Mechanical Dimensions**



# **Ordering Information**

Option	Description	
ML4025E-PLS	12 ps rise time TDR	
ML4025F-PLS	7 ps rise time TDR	
3YW	Total 3-year warranty	



### **Recommended Accessories**

Instrument	Recommended QSFPDD to SMPM Cable Assembly PN	Recommended OSFP to SMPM Cable Assembly PN
ML4025E-PLS	140-7046-516	142-7082-516





#### Figure 1 QSFP-DD to SMPM Cable Assembly

Figure 2 OSFP to SMPM Cable Assembly

Instrument	Recommended QSFPDD to SMPM Cable Assembly PN	Recommended OSFP to SMPM Cable Assembly PN
ML4025F-PLS	142-7316-100	142-7316-000





Figure 2 OSFP to SMPS Cable Assembly



Figure 1 QSFP-DD to SMP Cable Assembly



This equipment contains ESD sensitive components and may become damaged when contacted with an electrostatic charge. To prevent equipment damage, please use proper grounding techniques.

